

# 会议议程 Forum agenda

**上午主题:** 连接器行业设计、材料、工艺、检测、标准等基础共性技术研究

**AM Session:** Latest Development of Connector Basic Generic Technologies, Such as Design

主持人: 周明亮, 深圳市连接器行业协会, 先进基础材料应用研究中心

Moderator: Michael ZHOU, Material Research Center, Shenzhen Connector Industry Association

时间   Time	演讲题目   Presentation	演讲嘉宾   Speaker
9:25-9:50	智能制造对铜合金供应链的要求 The requirements of intelligent manufacturing for copper alloy	周明亮, 深圳市连接器行业协会, 先进基础材料应用研究中心 Michael ZHOU, Material Research Center, Shenzhen Connector Industry Association
9:50-10:00	致辞 Speech	杨奋为, 原上海航天技术研究院元器件可靠性中心, 高级工程师 Fenwei Yang, Senior Engineer, Shanghai Academy of Spaceflight Technology Components Reliability Center
10:00-10:30	2023 铜合金创新发展 Copper Alloy Innovation Developments 2023	史蒂芬·高, 宁波博威合金板带有限公司, 全球技术营销总监 Stephan Gross, Boway Global Director Technical Marketing, NINGBO BOWAY ALLOY PLATE AND STRIP CO.,LTD
10:30-11:00	智能物联高性能铜合金解决方案 Intelligent LOT High Performance Copper Alloy Solution	刘峰, 兴业合金材料集团有限公司, 博士(技术总监) Feng Liu, Doctor(Technical Director), Xingye Alloy Materials Group Limited
11:00-11:30	塞拉尼斯在连接器市场的整体解决方案 Celanese solutions for the connector market	张乃淳, 塞拉尼斯, 电子电气清洁能源全球市场经理 Richard Chang, Global Marketing Manager – E&E Clean Energy, Celanese
11:30-12:00	低碳再生铜材解决方案及应用实践 Solution and Application Practice of Low Carbon Recycled Copper Materials	郭超, 宁波金田铜业(集团)股份有限公司, 低碳可持续发展经理 Charles Guo, Sustainability Manager, Ningbo Jintian Copper (Group) CO.,LTD.

**下午主题:** 连接器技术趋势和发展

**PM Session:** Development Trend of Connector

主持人: 彭永权, 台湾电子连接产业协会, 秘书长

Moderator: YUNG CHUAN PENG, Secretary General, Taiwan Electronic Connector Association (TECA)

时间   Time	演讲题目   Presentation	演讲嘉宾   Speaker
13:00-13:30	国内连接器企业技术瓶颈探讨 Discussion of Technical Chokepoint in Chinese Connector Companies	许良军, 北京邮电大学, 教授 Liangjun Xu, Professor, Beijing University of Posts and Communications
13:30-14:00	VAVE降本技术在连接器行业里面的运用 The Application of VAVE Cost Reduction Technology in the Connector Industry	谭宇, 某知名的车载电子一级配套企业, 行业咨询顾问 Ryan Tan, Consultant, Tier-one
14:00-14:30	Molex莫仕连接解决方案及应用分享 Molex advanced interconnect solution	Rudy Liu, 莫仕, Molex莫仕亚太南区高级销售总监 Rudy Liu, Sr. Director Of Sales, Asia Pacific South, Molex
14:30-15:00	汽车新四化趋势下安费诺总体解决方案 Amphenol's Total Solution in the Context of CASE Vehicles in China	陈劲波, 安费诺信息通信, 中国区销售总监 新兴市场 Johnson Chen, China Sales Director Diversified Market, Amphenol Communications Solutions
15:00-15:30	高压连接器发展趋势及李尔大电流产品解决方案 High Voltage Connector mega trends and Lear's High Current Product Solutions	方超, 李尔(中国)投资有限公司, 高压工程经理 Fang Chard, High Voltage Engineering Manager, Lear (China) Holding Limited
15:30-16:00	用户侧储能的安全挑战和连接要求 Safety Challenges and Connectivity Requirements for User-side Energy Storage	宋玉明, 北京京北通宇电子元件有限公司, 首席科学家顾问 Yuming Song, Chief Scientist Advisor, Beijing Jingbei Components Co.ltd.
16:00-16:30	电子连接产业的发展与挑战 Challenge & Opportunities of the Interconnection Industry	彭永权, 台湾电子连接产业协会, 秘书长 YUNG CHUAN PENG, Secretary General, Taiwan Electronic Connector Association (TECA)